Low Distortion Internally Matched Power GaAs FETs (C-Band)

Features

- Low intermodulation distortion
 - $IM_3 = -45 \text{ dBc}$ at Po = 25 dBm,
 - Single carrier level
- High power
 - P_{1dB} = 36 dBm at 3.7 GHz to 4.2 GHz
- High gain
 - $G_{1dB} = 10.0 \text{ dB}$ at 3.7 GHz to 4.2 GHz
- · Broad band internally matched
- Hermetically sealed package

RF Performance Specifications (Ta = 25° C)

Characteristics	Symbol	Condition	Unit	Min.	Тур.	Max
Output Power at 1dB Compression Point	P _{1dB}		dBm	35.0	36.0	_
Power Gain at 1dB Compression Point	G _{1dB}	V _{DS} = 10V f = 3.7 ~ 4.2 GHz	dB	9.0	10.0	_
Drain Current	I _{DS1}		Α	_	1.1	1.5
Gain Flatness	ΔG		dB	_	_	±0.6
Power Added Efficiency	η _{add}		%	_	33	_
3rd Order Intermodulation Distortion	IM ₃	Note 1	dBc	-42	-45	_
Drain Current	I _{DS2}	14016 1	Α	_	1.1	1.5
Channel-Temperature Rise	ΔT_{ch}	V _{DS} xI _{DS} xR _{th} (c-c)	°C	_	_	80

Electrical Characteristics (Ta = 25° C)

Characteristic	Symbol	Condition	Unit	Min.	Тур.	Max
Trans-conductance	gm	$V_{DS} = 3V$ $I_{DS} = 1.5A$	mS	_	900	_
Pinch-off Voltage	V _{GSoff}	$V_{DS} = 3V$ $I_{DS} = 20mA$	V	-2	-3.5	-5.0
Saturated Drain Current	I _{DSS}	$V_{DS} = 3V$ $V_{GS} = 0V$	А	_	2.9	3.8
Gate-Source Breakdown Voltage	V _{GSO}	I _{GS} = -60μA	V	-5	_	_
Thermal Resistance	R _{th (c-c)}	Channel to case	°C/W	_	4	6

Note 1: 2 tone Test Pout = 25dBm Single Carrier Level.

The information contained here is subject to change without notice.

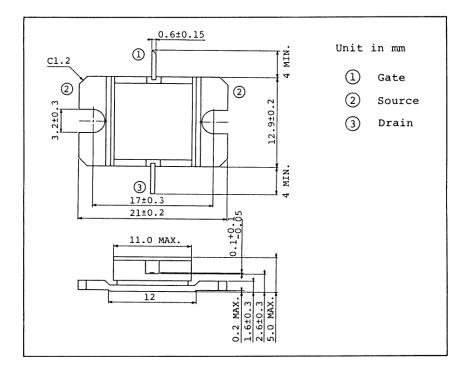
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Absolute Maximum Ratings (Ta = 25° C)

Characteristic	Symbol	Unit	Rating
Drain-Source Voltage	V _{DS}	V	15
Gate-Source Voltage	V _{GS}	V	-5
Drain Current	I _{DS}	А	4
Total Power Dissipation (T _c = 25°C)	P _T	W	20
Channel Temperature	T _{ch}	°C	175
Storage Temperature	T _{stg}	°C	-65~175

Package Outline (2-11D1B)



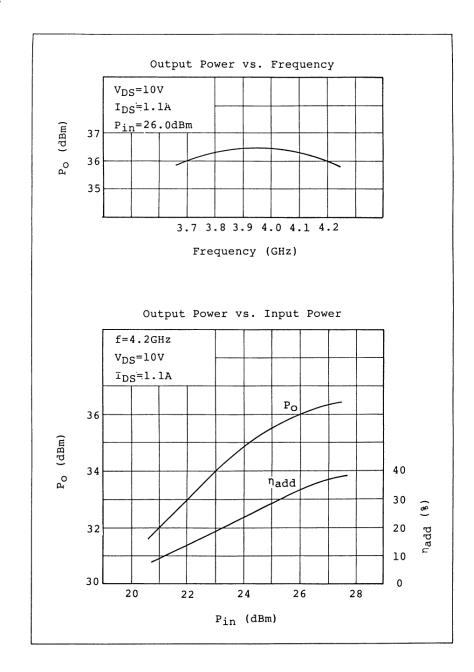
Handling Precautions for Packaged Type

Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

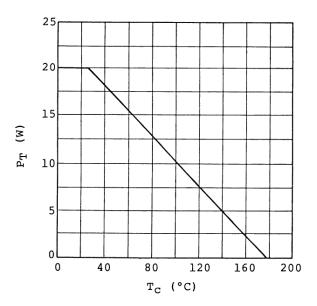
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RF Performances

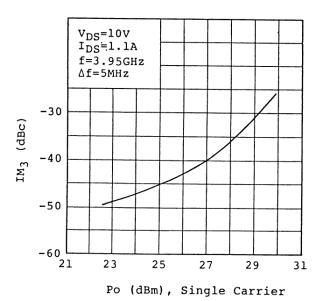


Power Dissipation vs. Case Temperature



IM₃ vs. Output Power Characteristics

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TIM3742-4L S-Parameters (MAGN. and ANGLES)

 V_{DS} = 10 V, I_{DS} = 1.0 A

